As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name

I be been I am the original, first and sole inventor (if only one name is listed below) or an original, first inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

		•	*	
THIN FIL	M SHA	PE MEMORY ALLOY AC	CTUATED MICROREL	AY
the specification of	which			
(Check		is attached hereto		,
one)	X	was filed on	3/28/2001	as
		Application Serial No.	09/821,840	-
		and was amended on		-
			(if applicable)	•
		riewed and understand the conte y amendment referred to above.		d specification, including
I acknowledge the departmentability as defi		disclose to the Patent Offic 37 C.F.R. 1.56.	e all information known	to me to be material to

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

	Prior Foreign Appli	cation(s)	<u>Priority Claimed</u>			
	(Number)	(Country)	((Day/Month/Year Filed)	Yes	No	
			• •			
,	(Number)	(Country)	(Day/Month/Year Filed)	Yes	Ио	
I hereby	/ claim the benefit un	der 35 U.S.C. 119(e)	of any United States provisiona	l applicatio	on(s) listed	below.
	60/192 _i 766		3/28/2000			
	(Provisional Appl	ication Number)	(Filing Date)	•		
	•					

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose to the Patent Office all information known to me to be material to patentability as defined in 37 C.F.R. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status)
•		(patented, pending, abandoned)

I hereby appoint, for the benefit of and as agent for the Assignee ι , this application and to my exclusion if there is now or hereafter such an Assignee:

Richard E. Backus, Reg. No. 22,701

attorney with full power of substitution and revocation to prosecute the above-identified application for Letters Patent and to transact all business in the Patent Office connected therewith.

Direct all telephone calls to <u>Richard E. Backus</u> at (415) 979-9876. Address all correspondence to:

Richard E. Backus Law Offices of Richard E. Backus 685 Market Street, Suite 490 San Francisco, CA 94105

File No. A-70168

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or	
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Inventor's signature:	a David Johnson
Date:	79 May 2001
Residence:	San Leandro, California
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Post Office Address:	1621 Neptune Drive San Leandro, CA 94577
•	
Full name of sole or	` .
first inventor:	Vikas Galhotra
Inventor's signature:	hicken
Date:	06/09/2001
Residence:	Union City California
Citizenship:	INDIA
Post Office Address:	2644 Rainier Ct
	Union City CA-94587

I hereby appoint, for the benefit of and as agent for the Assignee this application and to my exclusion if there is now or hereafter such an Assignee:

Richard E. Backus, Reg. No. 22,701

attorney with full power of substitution and revocation to prosecute the above-identified application for Letters Patent and to transact all business in the Patent Office connected therewith.

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Full name of sole or	A
first inventor:	Vikas Gupta
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